



Click here for the 3D model.

Dimensions	
Chip Size	1210
L	3.07mm +/-0.38mm (0.121 in +/-0.015 in)
W	2.56mm +/-0.38mm (0.101 in +/-0.015 in)
Т	1.6mm MAX (0.063 in MAX)
В	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

General Information		
Series	GR900 SMD Space	
Style	SMD Chip	
RoHS	Yes	
Termination	Tin	
Failure Rate	N/A	
Testing and Reliability	GR900 CSAM A	
AEC-Q200	No	
Shelf Life	78 Weeks	
MSL	1	

Specifications			
Capacitance	0.022 uF		
Capacitance Tolerance	10%		
Voltage DC	100 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	BX		

Packaging Specifications

Packaging

Bulk, Bag

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